



3.3V CMOS Static RAM 4 Meg (256K x 16-Bit)

IDT71V416YS
IDT71V416YL

Features

- ♦ 256K x 16 advanced high-speed CMOS Static RAM
- ♦ JEDEC Center Power / GND pinout for reduced noise.
- ♦ Equal access and cycle times
 - Commercial and Industrial: 10/12/15ns
- ♦ One Chip Select plus one Output Enable pin
- ♦ Bidirectional data inputs and outputs directly LVTTTL-compatible
- ♦ Low power consumption via chip deselect
- ♦ Upper and Lower Byte Enable Pins
- ♦ Single 3.3V power supply
- ♦ Available in 44-pin, 400 mil plastic SOJ package and a 44-pin, 400 mil TSOP Type II package and a 48 ball grid array, 9mm x 9mm package.

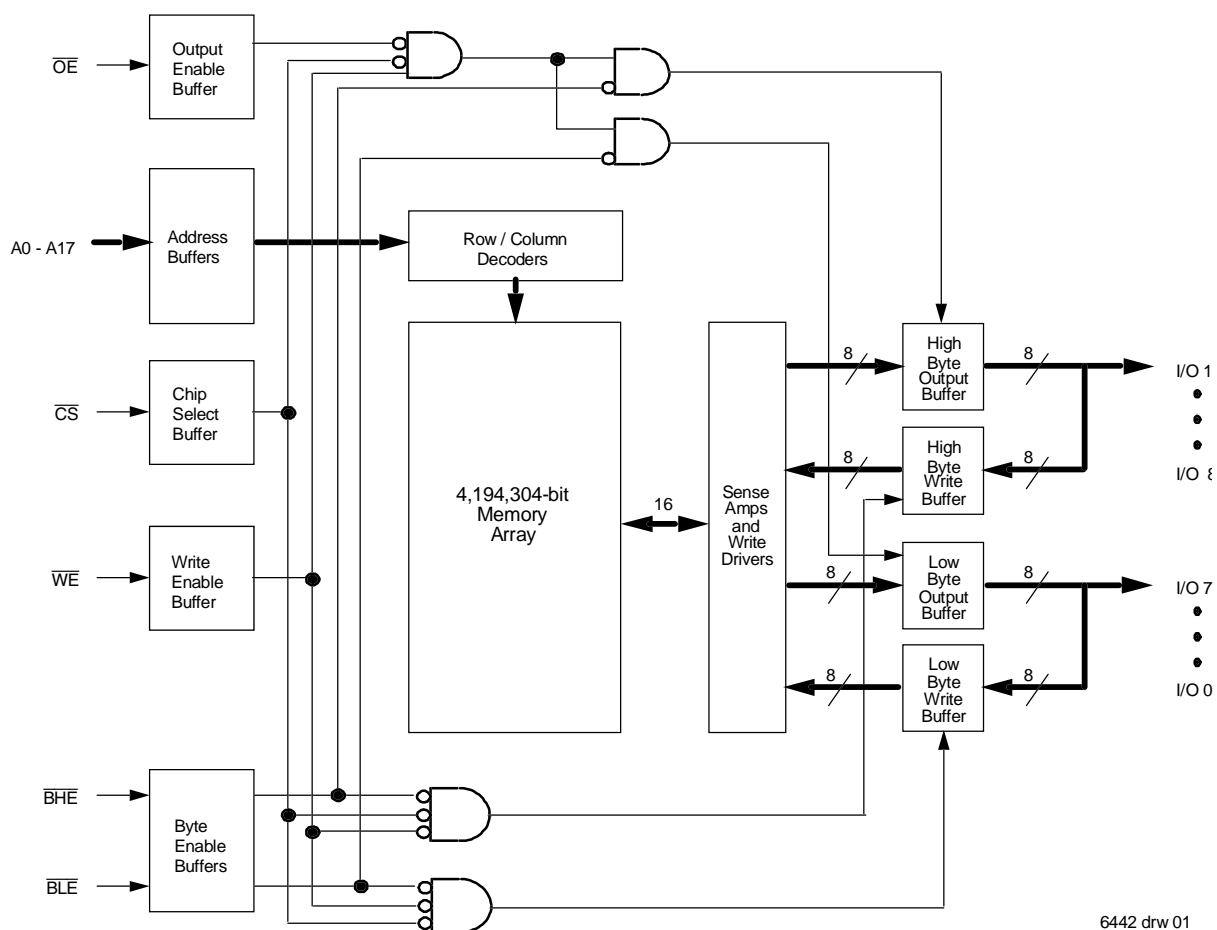
Description

The IDT71V416 is a 4,194,304-bit high-speed Static RAM organized as 256K x 16. It is fabricated using IDT's high-performance, high-reliability CMOS technology. This state-of-the-art technology, combined with innovative circuit design techniques, provides a cost-effective solution for high-speed memory needs.

The IDT71V416 has an output enable pin which operates as fast as 5ns, with address access times as fast as 10ns. All bidirectional inputs and outputs of the IDT71V416 are LVTTTL-compatible and operation is from a single 3.3V supply. Fully static asynchronous circuitry is used, requiring no clocks or refresh for operation.

The IDT71V416 is packaged in a 44-pin, 400 mil Plastic SOJ and a 44-pin, 400 mil TSOP Type II package and a 48 ball grid array, 9mm x 9mm package.

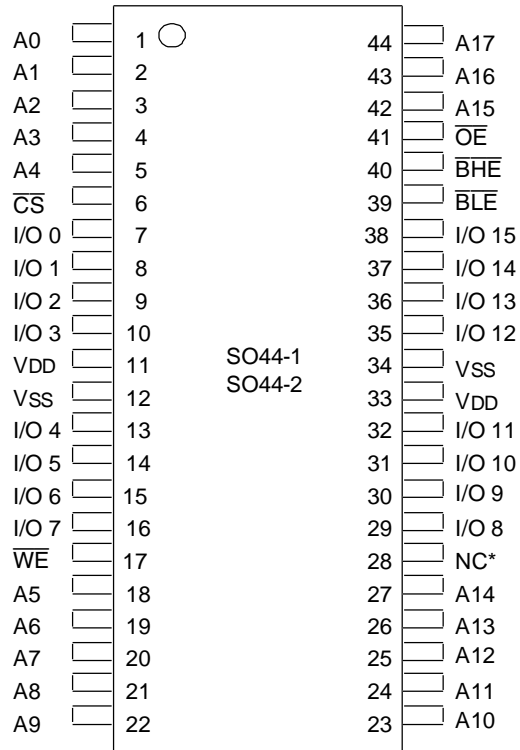
Functional Block Diagram



6442 drw 01

OCTOBER 2003

Pin Configurations - SOJ/TSOP



6442 drw 02

*Pin 28 can either be a NC or connected to Vss

Top View

Pin Descriptions

A0 - A17	Address Inputs	Input
CS	Chip Select	Input
WE	Write Enable	Input
OE	Output Enable	Input
BHE	High Byte Enable	Input
BLE	Low Byte Enable	Input
I/O0 - I/O15	Data Input/Output	I/O
VDD	3.3V Power	Pwr
VSS	Ground	Gnd

6442 tbl 01

Pin Configurations - 48 BGA



6442 tbl 11

SOJ Capacitance

(TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Max.	Unit
CIN	Input Capacitance	VIN = 3dV	7	pF
CIO	I/O Capacitance	VOUT = 3dV	8	pF

6442 tbl 02

48 BGA Capacitance

(TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Max.	Unit
CIN	Input Capacitance	VIN = 3dV	6	pF
CIO	I/O Capacitance	VOUT = 3dV	7	pF

6442 tbl 02b

NOTE:

1. This parameter is guaranteed by device characterization, but not production tested.

Absolute Maximum Ratings⁽¹⁾

Symbol	Rating	Value	Unit
V _{DD}	Supply Voltage Relative to V _{SS}	-0.5 to +4.6	V
V _{IN} , V _{OUT}	Terminal Voltage Relative to V _{SS}	-0.5 to V _{DD} +0.5	V
T _{BIAS}	Temperature Under Bias	-55 to +125	°C
T _{STG}	Storage Temperature	-55 to +125	°C
P _T	Power Dissipation	1	W
I _{OUT}	DC Output Current	50	mA

6442 tbl 04

NOTE:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Recommended Operating Temperature and Supply Voltage

Grade	Temperature	V _{SS}	V _{DD}
Commercial	0°C to +70°C	0V	See Below
Industrial	-40°C to +85°C	0V	See Below

6442 tbl 05

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
V _{DD}	Supply Voltage	3.0	3.3	3.6	V
V _{SS}	Ground	0	0	0	V
V _{IH}	Input High Voltage	2.0	—	V _{DD} +0.3 ⁽¹⁾	V
V _{IL}	Input Low Voltage	-0.3 ⁽²⁾	—	0.8	V

6442 tbl 06

NOTES:

- V_{IH} (max.) = V_{DD}+2V for pulse width less than 5ns, once per cycle.
- V_{IL} (min.) = -2V for pulse width less than 5ns, once per cycle.

Truth Table⁽¹⁾

\overline{CS}	\overline{OE}	\overline{WE}	\overline{BLE}	\overline{BHE}	I/O ₀ -I/O ₇	I/O ₈ -I/O ₁₅	Function
H	X	X	X	X	High-Z	High-Z	Deselected - Standby
L	L	H	L	H	DATA _{OUT}	High-Z	Low Byte Read
L	L	H	H	L	High-Z	DATA _{OUT}	High Byte Read
L	L	H	L	L	DATA _{OUT}	DATA _{OUT}	Word Read
L	X	L	L	L	DATA _{IN}	DATA _{IN}	Word Write
L	X	L	L	H	DATA _{IN}	High-Z	Low Byte Write
L	X	L	H	L	High-Z	DATA _{IN}	High Byte Write
L	H	H	X	X	High-Z	High-Z	Outputs Disabled
L	X	X	H	H	High-Z	High-Z	Outputs Disabled

6442 tbl 03

NOTE:

- H = V_{IH}, L = V_{IL}, X = Don't care.

DC Electrical Characteristics

(V_{DD} = Min. to Max., Commercial and Industrial Temperature Ranges)

Symbol	Parameter	Test Conditions	IDT71V416		Unit
			Min.	Max.	
I _{IL}	Input Leakage Current	V _{CC} = Max., V _{IN} = V _{SS} to V _{DD}	—	5	μA
I _{LO}	Output Leakage Current	V _{DD} = Max., $\overline{CS} = V_{IH}$, V _{OUT} = V _{SS} to V _{DD}	—	5	μA
V _{OL}	Output Low Voltage	I _{OL} = 8mA, V _{DD} = Min.	—	0.4	V
V _{OH}	Output High Voltage	I _{OH} = -4mA, V _{DD} = Min.	2.4	—	V

6442 tbl 07

DC Electrical Characteristics^(1, 2, 3)

(V_{DD} = Min. to Max., V_{LC} = 0.2V, V_{HC} = V_{DD} - 0.2V)

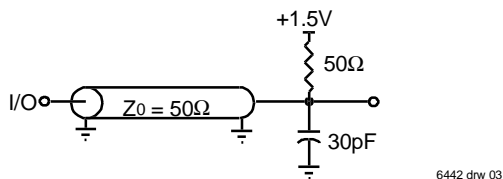
Symbol	Parameter		71V416S/L10		71V416S/L12		71V416S/L15		Unit
			Com'l.	Ind. ⁽⁵⁾	Com'l.	Ind.	Com'l.	Ind.	
I _{CC}	Dynamic Operating Current $\overline{CS} \leq V_{LC}$, Outputs Open, V _{DD} = Max., f = f _{MAX} ⁽⁴⁾	S	200	200	180	180	170	170	mA
		L	180	—	170	170	160	160	
I _{SB}	Dynamic Standby Power Supply Current $\overline{CS} \geq V_{HC}$, Outputs Open, V _{DD} = Max., f = f _{MAX} ⁽⁴⁾	S	70	70	60	60	50	50	mA
		L	50	—	45	45	40	40	
I _{SB1}	Full Standby Power Supply Current (static) $\overline{CS} \geq V_{HC}$, Outputs Open, V _{DD} = Max., f = 0 ⁽⁴⁾	S	20	20	20	20	20	20	mA
		L	10	—	10	10	10	10	

6442 tbl 08

NOTES:

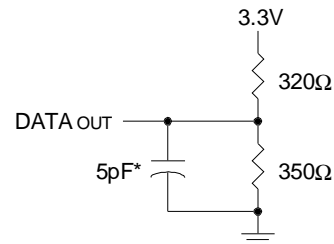
1. All values are maximum guaranteed values.
2. All inputs switch between 0.2V (Low) and V_{DD} - 0.2V (High).
3. Power specifications are preliminary.
4. f_{MAX} = 1/trc (all address inputs are cycling at f_{MAX}); f = 0 means no address input lines are changing.
5. Standard power 10ns (S10) speed grade only.

AC Test Loads



6442 drw 03

Figure 1. AC Test Load

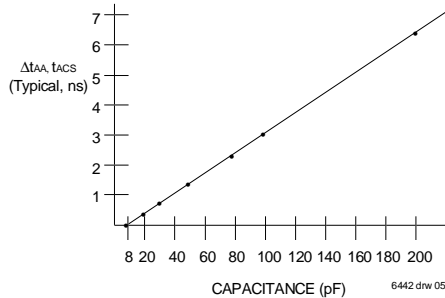


6442 drw 04

*Including jig and scope capacitance.

Figure 2. AC Test Load

(for t_{CLZ}, t_{OLZ}, t_{CHZ}, t_{OHZ}, t_{OW}, and t_{WHZ})



6442 drw 05

Figure 3. Output Capacitive Derating

AC Test Conditions

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	1.5ns
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
AC Test Load	Figures 1,2 and 3

6442 tbl 09

AC Electrical Characteristics

(VDD = Min. to Max., Commercial and Industrial Temperature Ranges)

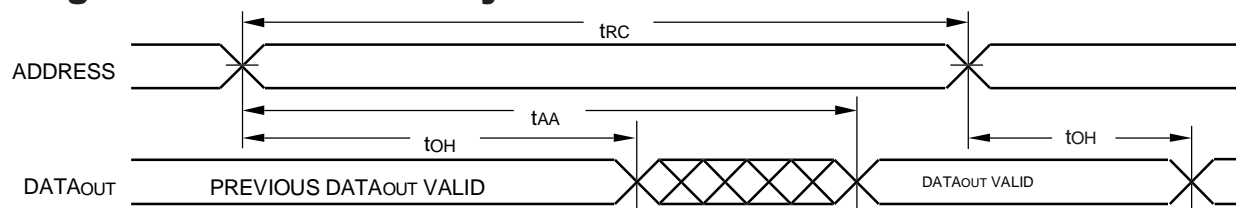
Symbol	Parameter	71V416S/L10 ⁽²⁾		71V416S/L12		71V416S/L15		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE								
t _{RC}	Read Cycle Time	10	—	12	—	15	—	ns
t _{AA}	Address Access Time	—	10	—	12	—	15	ns
t _{ACS}	Chip Select Access Time	—	10	—	12	—	15	ns
t _{CLZ} ⁽¹⁾	Chip Select Low to Output in Low-Z	4	—	4	—	4	—	ns
t _{CHZ} ⁽¹⁾	Chip Select High to Output in High-Z	—	5	—	6	—	7	ns
t _{OE}	Output Enable Low to Output Valid	—	5	—	6	—	7	ns
t _{OLZ} ⁽¹⁾	Output Enable Low to Output in Low-Z	0	—	0	—	0	—	ns
t _{OHZ} ⁽¹⁾	Output Enable High to Output in High-Z	—	5	—	6	—	7	ns
t _{OH}	Output Hold from Address Change	4	—	4	—	4	—	ns
t _{BE}	Byte Enable Low to Output Valid	—	5	—	6	—	7	ns
t _{BLZ} ⁽¹⁾	Byte Enable Low to Output in Low-Z	0	—	0	—	0	—	ns
t _{BHZ} ⁽¹⁾	Byte Enable High to Output in High-Z	—	5	—	6	—	7	ns
WRITE CYCLE								
t _{WC}	Write Cycle Time	10	—	12	—	15	—	ns
t _{AW}	Address Valid to End of Write	8	—	8	—	10	—	ns
t _{CW}	Chip Select Low to End of Write	8	—	8	—	10	—	ns
t _{BW}	Byte Enable Low to End of Write	8	—	8	—	10	—	ns
t _{AS}	Address Set-up Time	0	—	0	—	0	—	ns
t _{WR}	Address Hold from End of Write	0	—	0	—	0	—	ns
t _{WP}	Write Pulse Width	8	—	8	—	10	—	ns
t _{DW}	Data Valid to End of Write	5	—	6	—	7	—	ns
t _{DH}	Data Hold Time	0	—	0	—	0	—	ns
t _{OW} ⁽¹⁾	Write Enable High to Output in Low-Z	3	—	3	—	3	—	ns
t _{WHZ} ⁽¹⁾	Write Enable Low to Output in High-Z	—	6	—	7	—	7	ns

6442 tbl 10

NOTE:

- This parameter is guaranteed with the AC Load (Figure 2) by device characterization, but is not production tested.
- Low power 10ns (L10) speed 0°C to +70°C temperature range only.

Timing Waveform of Read Cycle No. 1^(1,2,3)

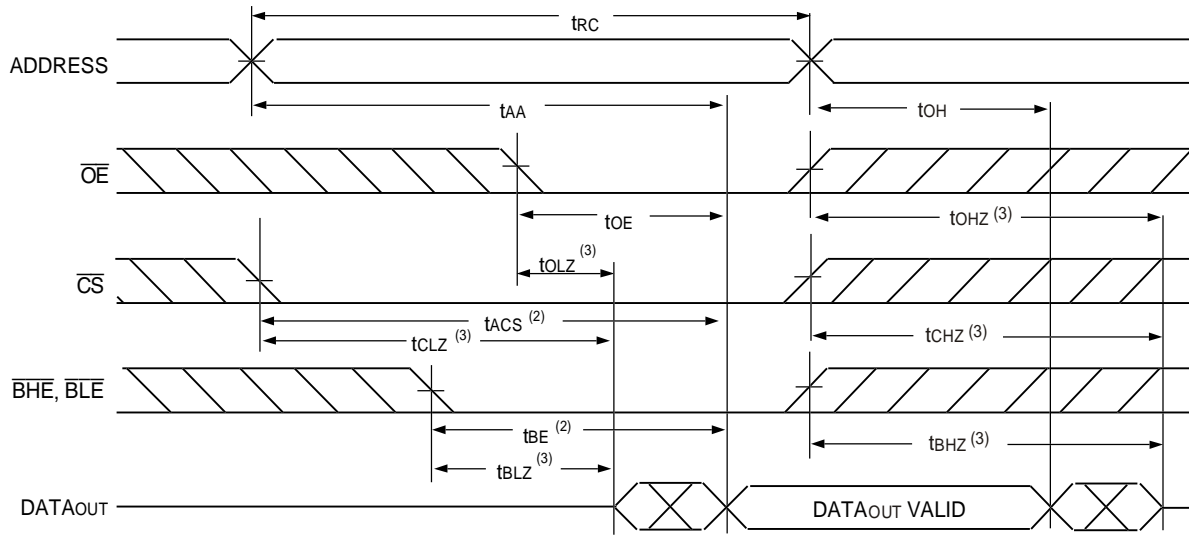


6442d06

NOTES:

- \overline{WE} is HIGH for Read Cycle.
- Device is continuously selected, \overline{CS} is LOW.
- \overline{OE} , \overline{BHE} , and \overline{BLE} are LOW.

Timing Waveform of Read Cycle No. 2⁽¹⁾

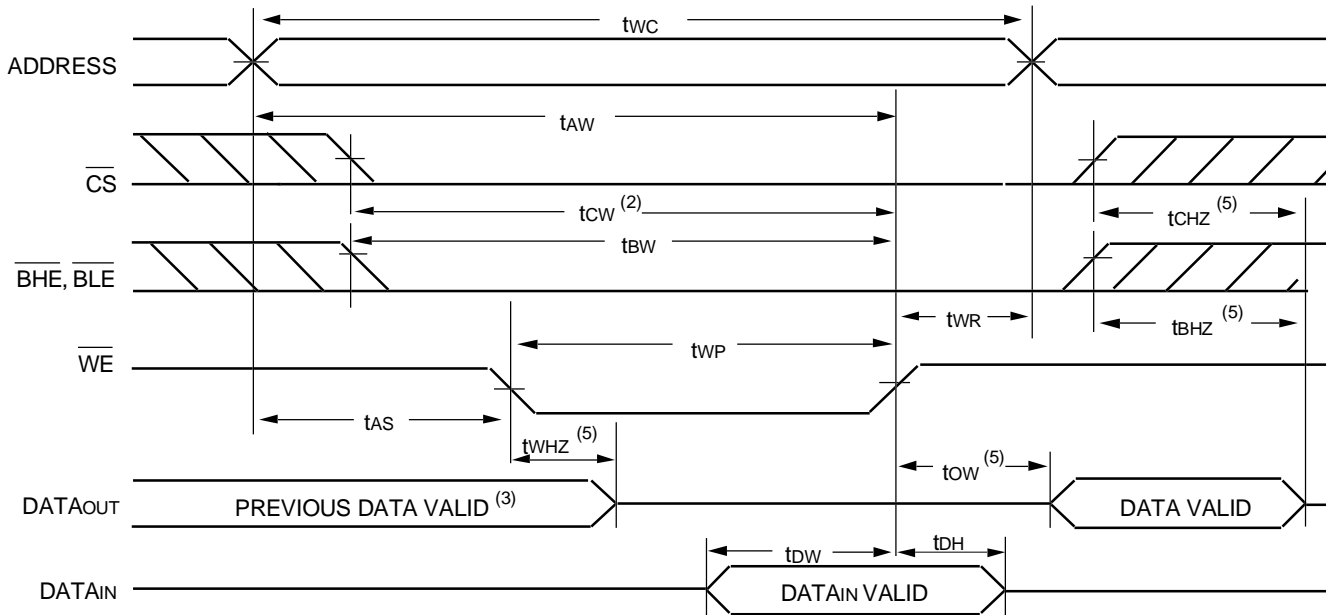


6442 drw 07

NOTES:

1. \overline{WE} is HIGH for Read Cycle.
2. Address must be valid prior to or coincident with the later of \overline{CS} , \overline{BHE} , or \overline{BLA} transition LOW; otherwise t_{AA} is the limiting parameter.
3. Transition is measured $\pm 200\text{mV}$ from steady state.

Timing Waveform of Write Cycle No. 1 (\overline{WE} Controlled Timing)^(1,2,4)

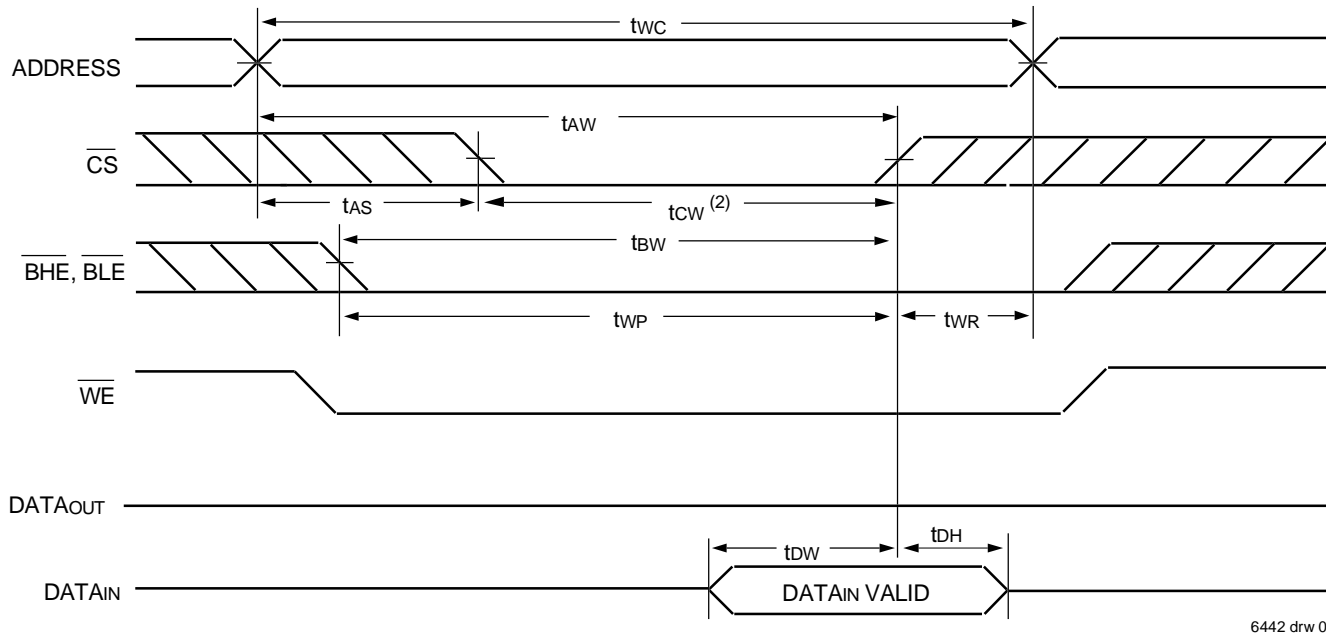


6442 drw 08

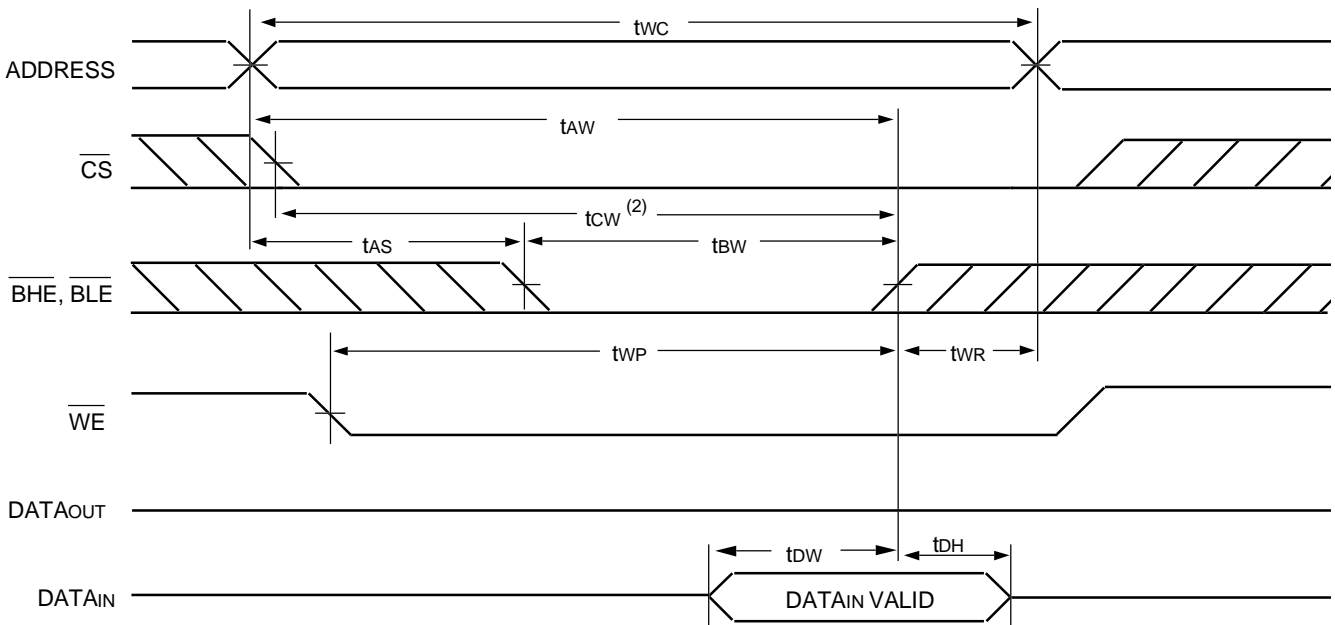
NOTES:

1. A write occurs during the overlap of a LOW \overline{CS} , LOW \overline{BHE} or \overline{BLA} , and a LOW \overline{WE} .
2. \overline{OE} is continuously HIGH. If during a \overline{WE} controlled write cycle \overline{OE} is LOW, t_{WP} must be greater than or equal to $t_{WHZ} + t_{DW}$ to allow the I/O drivers to turn off and data to be placed on the bus for the required t_{DW} . If \overline{OE} is HIGH during a \overline{WE} controlled write cycle, this requirement does not apply and the minimum write pulse is as short as the specified t_{WP} .
3. During this period, I/O pins are in the output state, and input signals must not be applied.
4. If the \overline{CS} LOW or \overline{BHE} and \overline{BLA} LOW transition occurs simultaneously with or after the \overline{WE} LOW transition, the outputs remain in a high-impedance state.
5. Transition is measured $\pm 200\text{mV}$ from steady state.

Timing Waveform of Write Cycle No. 2 (\overline{CS} Controlled Timing)^(1,3)



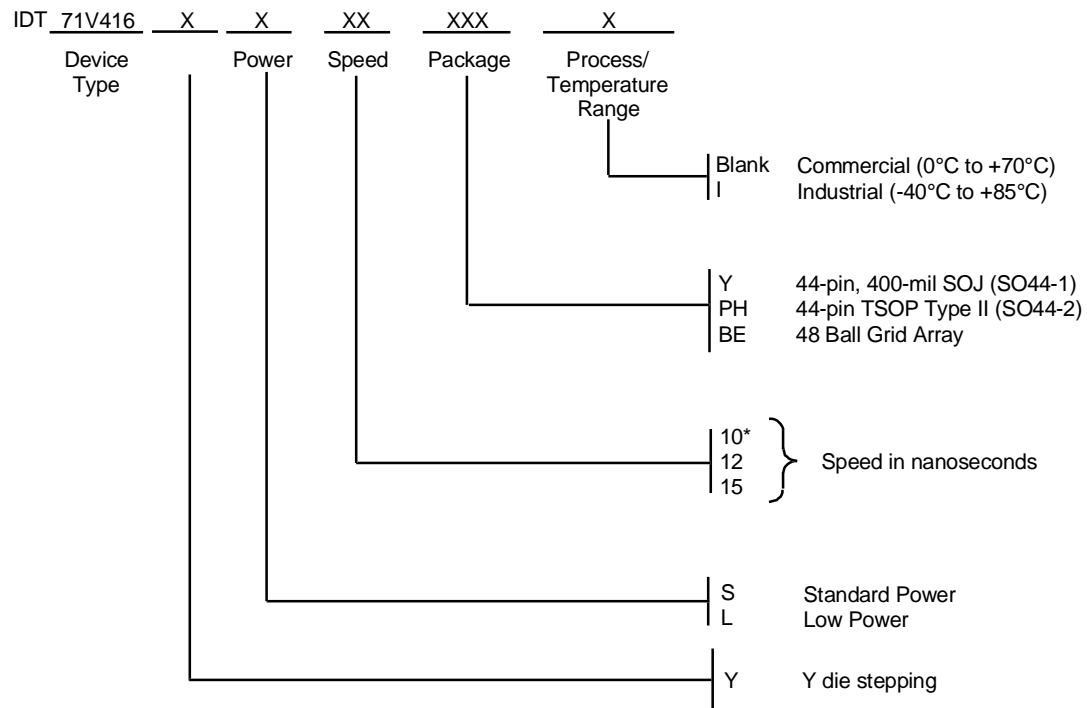
Timing Waveform of Write Cycle No. 3 (\overline{BHE} , \overline{BLA} Controlled Timing)^(1,3)



NOTES:

1. A write occurs during the overlap of a LOW \overline{CS} , LOW \overline{BHE} or \overline{BLA} , and a LOW \overline{WE} .
2. During this period, I/O pins are in the output state, and input signals must not be applied.
3. If the \overline{CS} LOW or \overline{BHE} and \overline{BLA} LOW transition occurs simultaneously with or after the \overline{WE} LOW transition, the outputs remain in a high-impedance state.

Ordering Information



* Commercial only for low power 10ns (L10) speed grade.

6442 drw 11a

Datasheet Document History

10/13/03

Released datasheet



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